

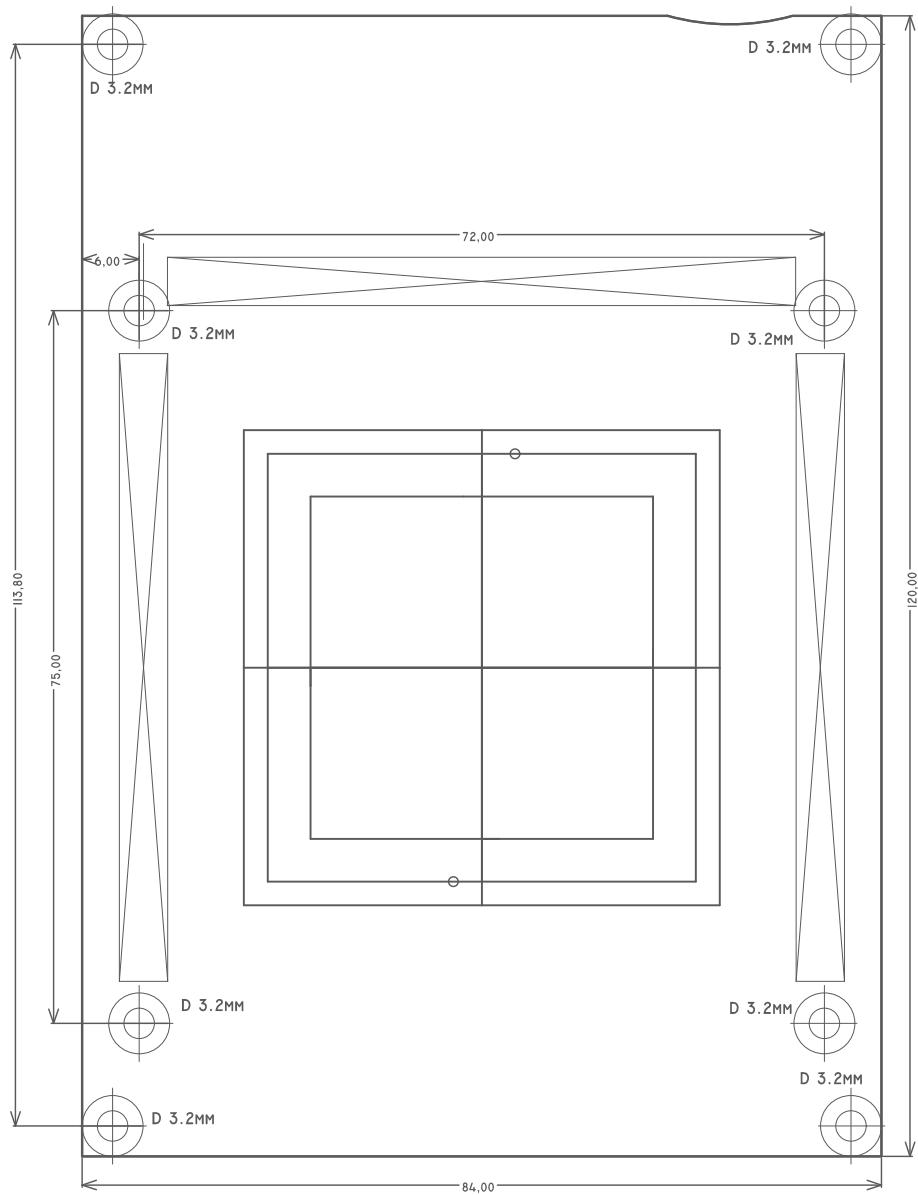
PCB Note

TENDING ALL HOLE VIAS 0.3MM.

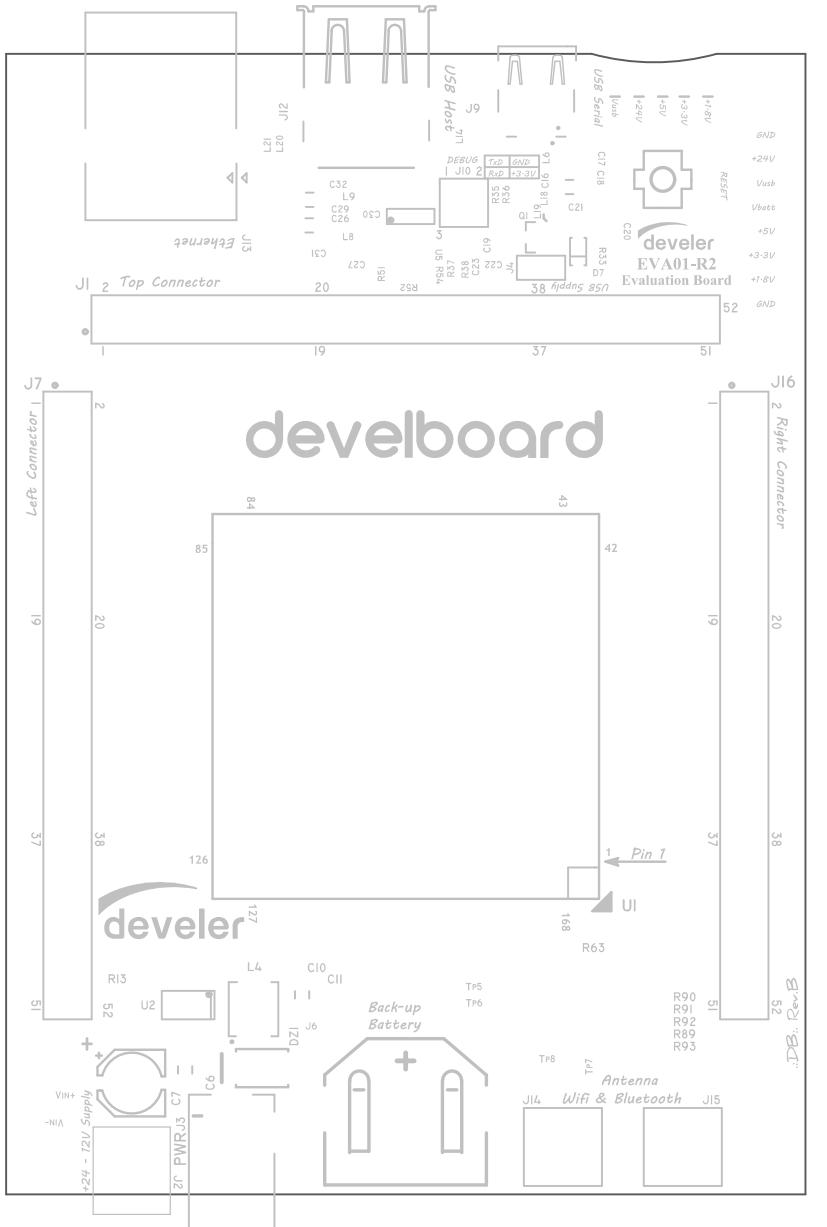
## IMPEDANCE CONTROL:

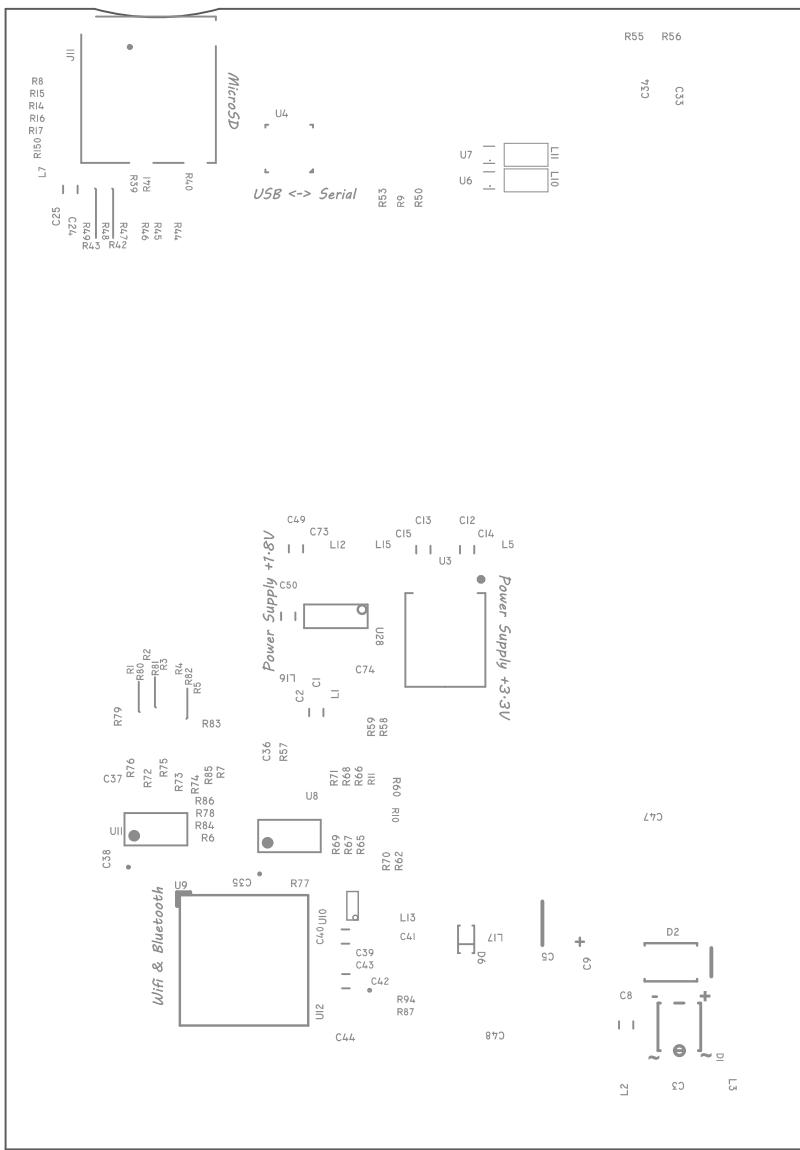
- BOTTOM 100OHM +/-10% DIFFERENTIAL SIGNAL
  - BOTTOM 90OHM +/-10% DIFFERENTIAL SIGNAL

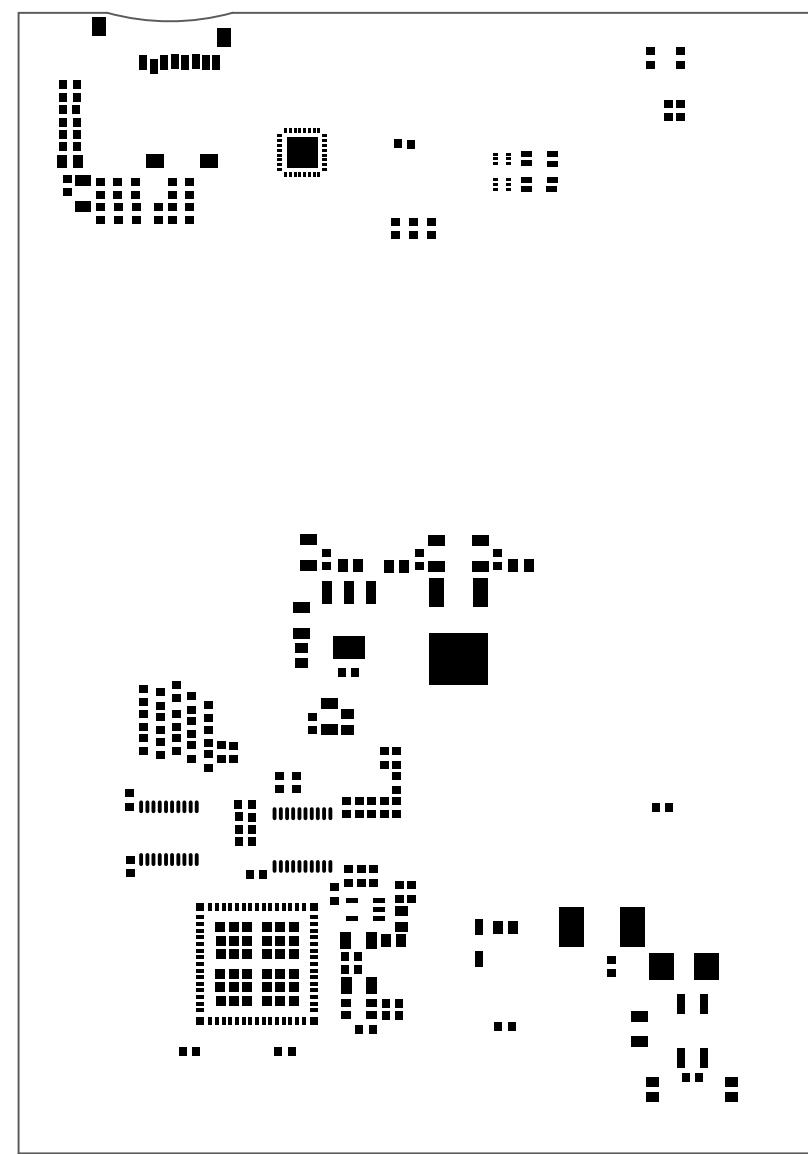
## MECHANICAL CHARACTERISTICS

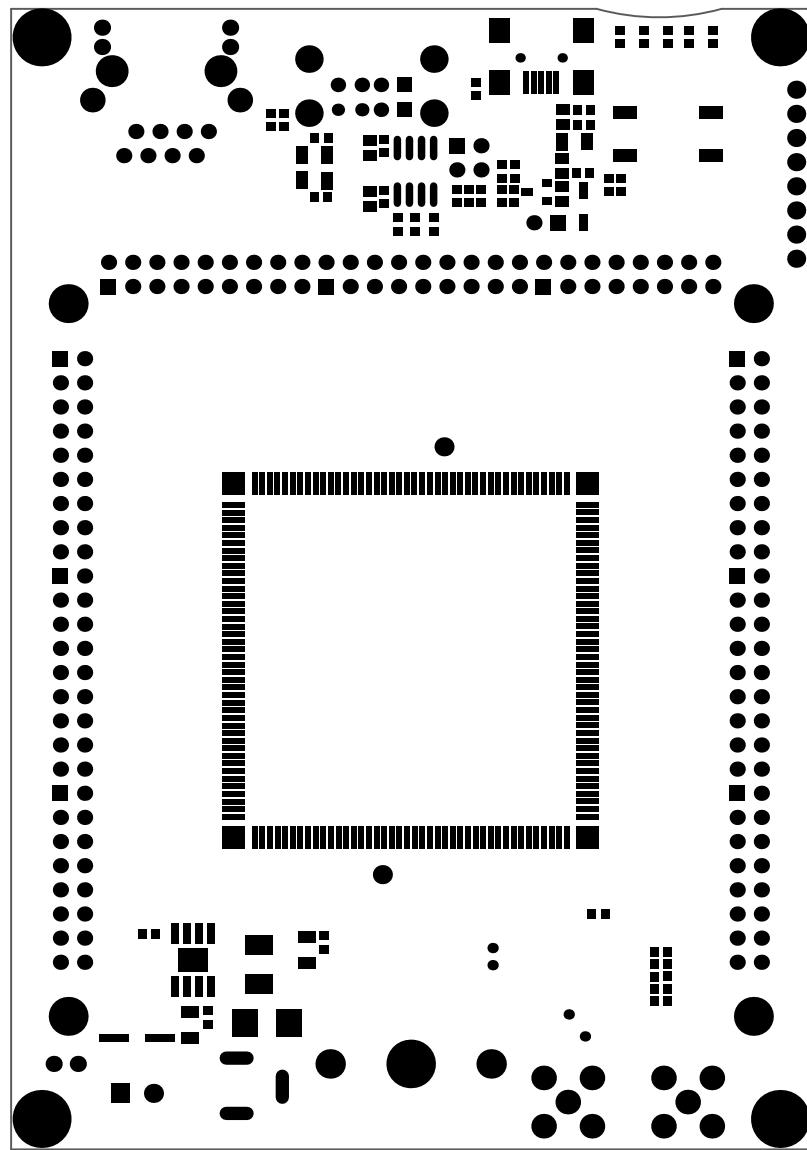


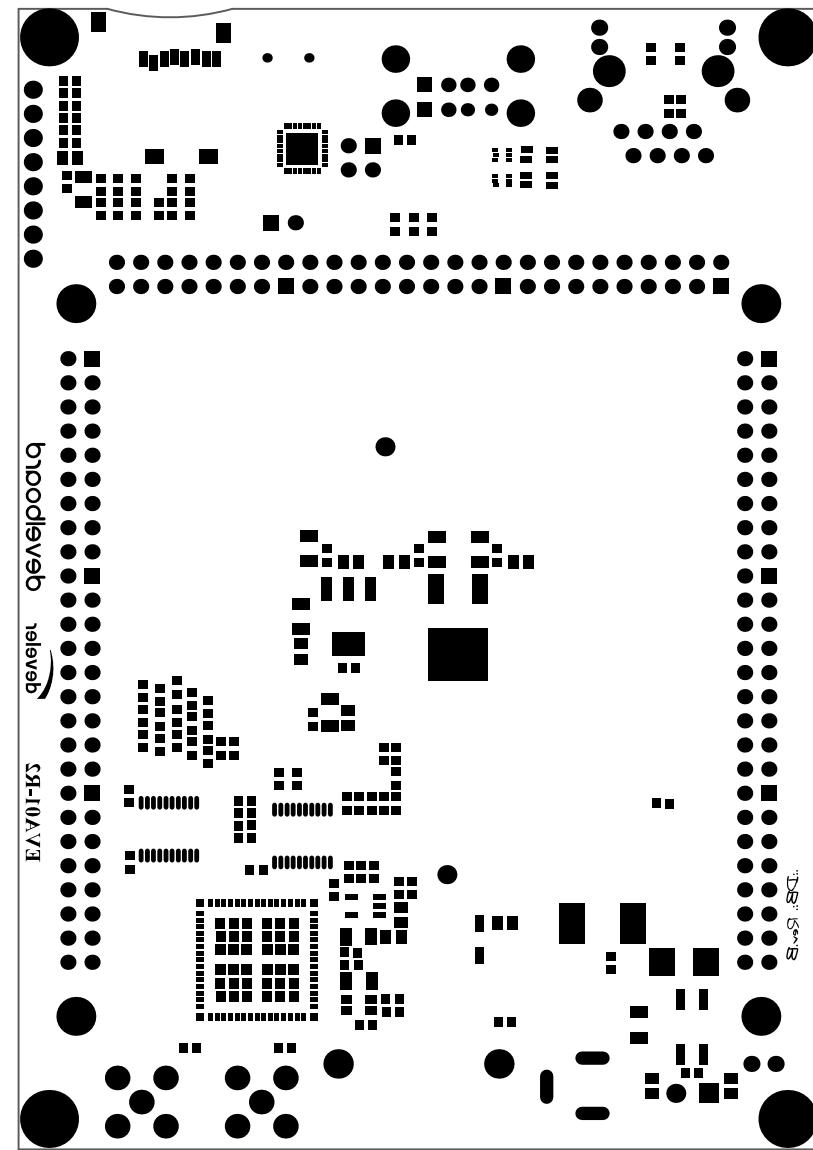
LAYER	NAME	MATERIAL	THICKNESS	CONSTANT	BOARD LAYER STACK
I	TOP OVERLAY				
2	TOP SOLDER	SOLDER RESIST	0,010MM	3,5	
3	TOP LAYER	COPPER	0,035MM		
4	DIELECTRIC1	2x7628	0,408MM	4,2	
5	INNER	COPPER	0,036MM		
6	DIELECTRIC2	FR-4	0,710MM	4,2	
7	GND	COPPER	0,036MM		
8	DIELECTRIC3	2x7628	0,408MM	4,2	
9	BOTTOM LAYER	COPPER	0,035MM		
10	BOTTOM SOLDER	SOLDER RESIST	0,010MM	3,5	
II	BOTTOM OVERLAY				

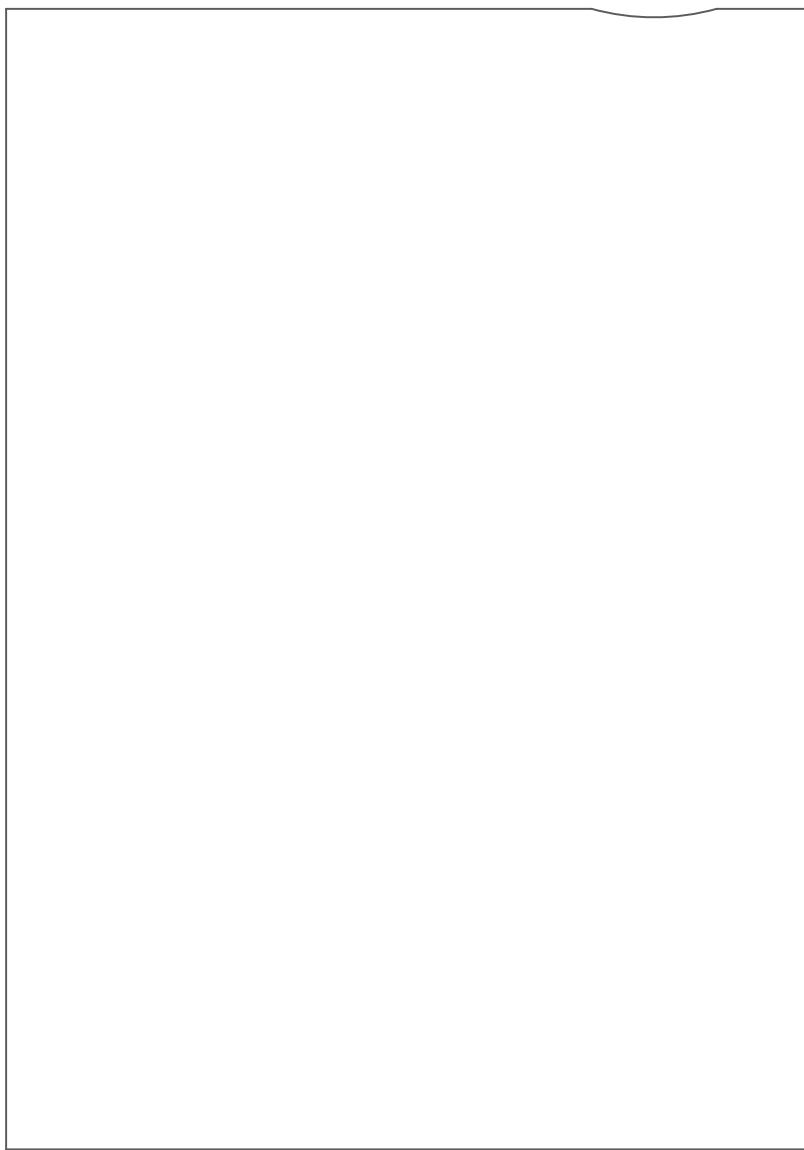




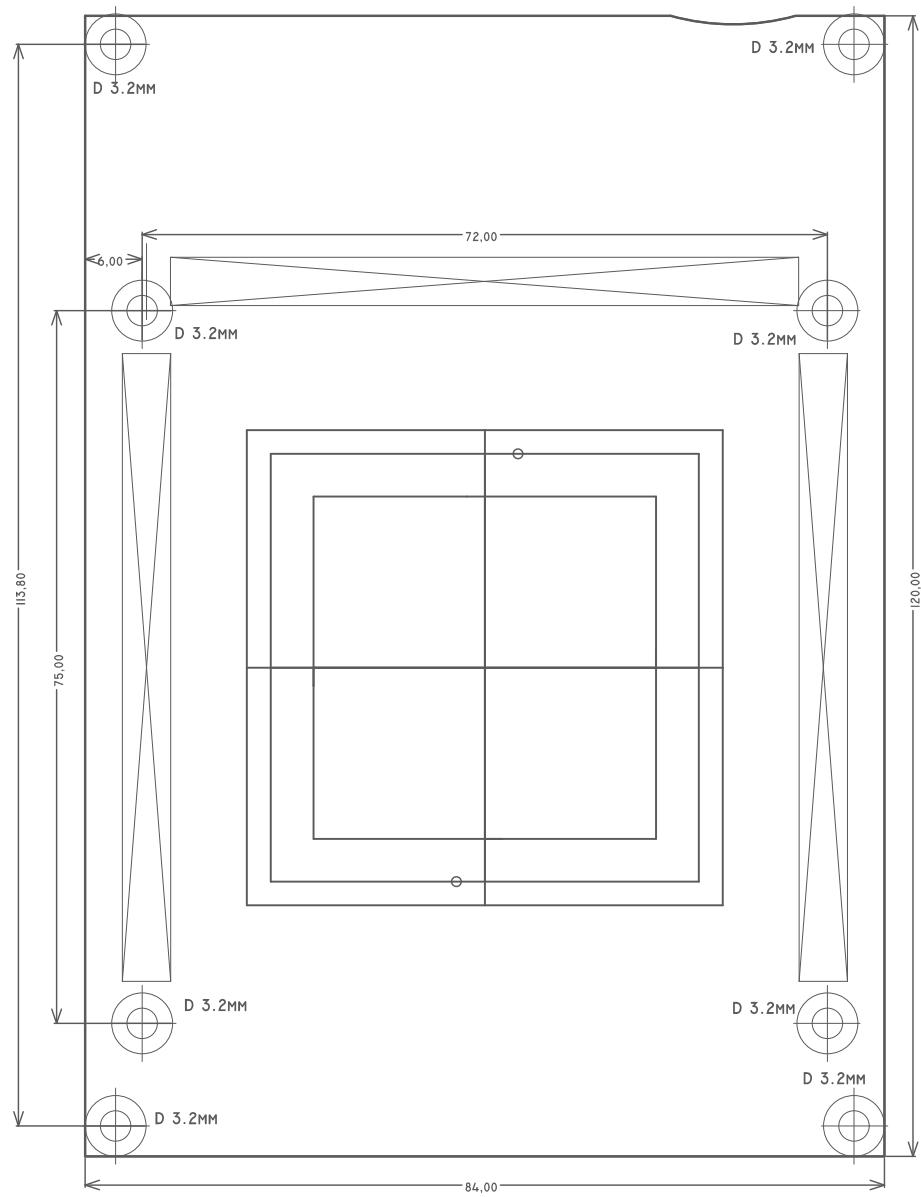




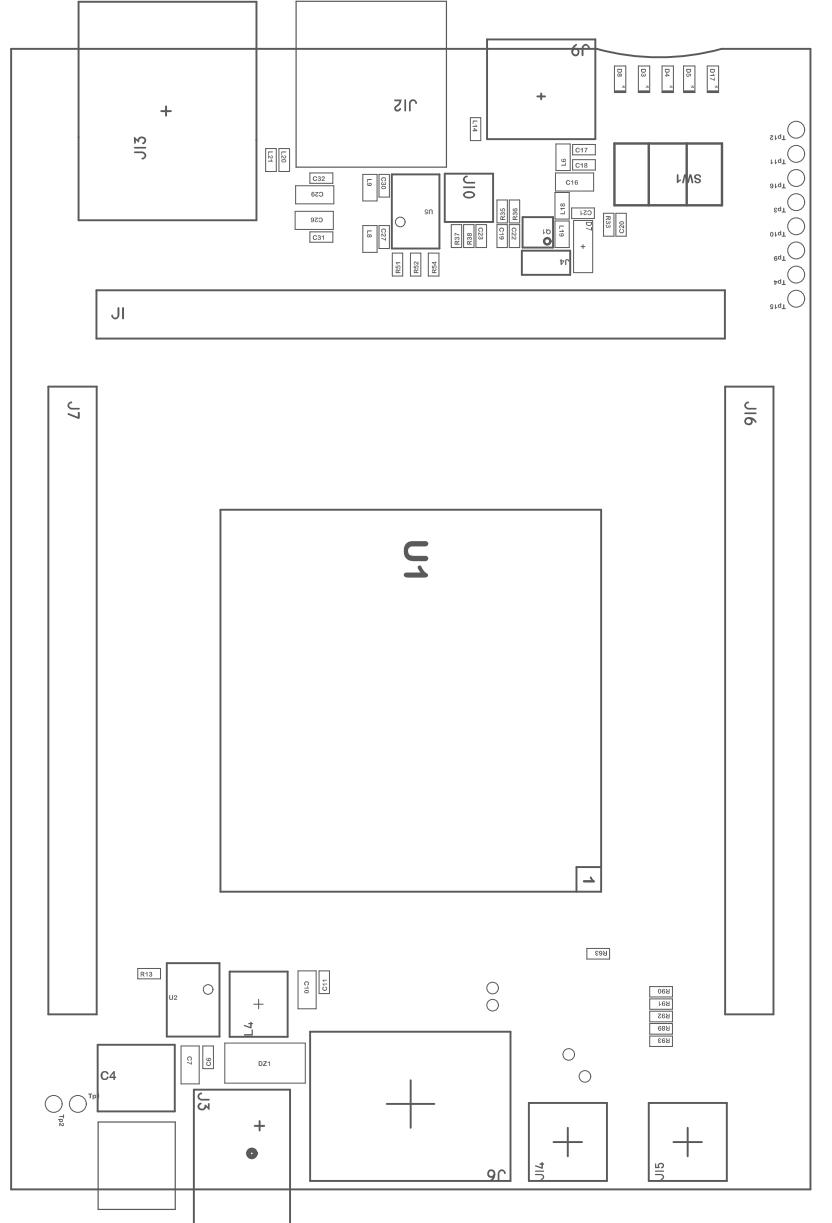




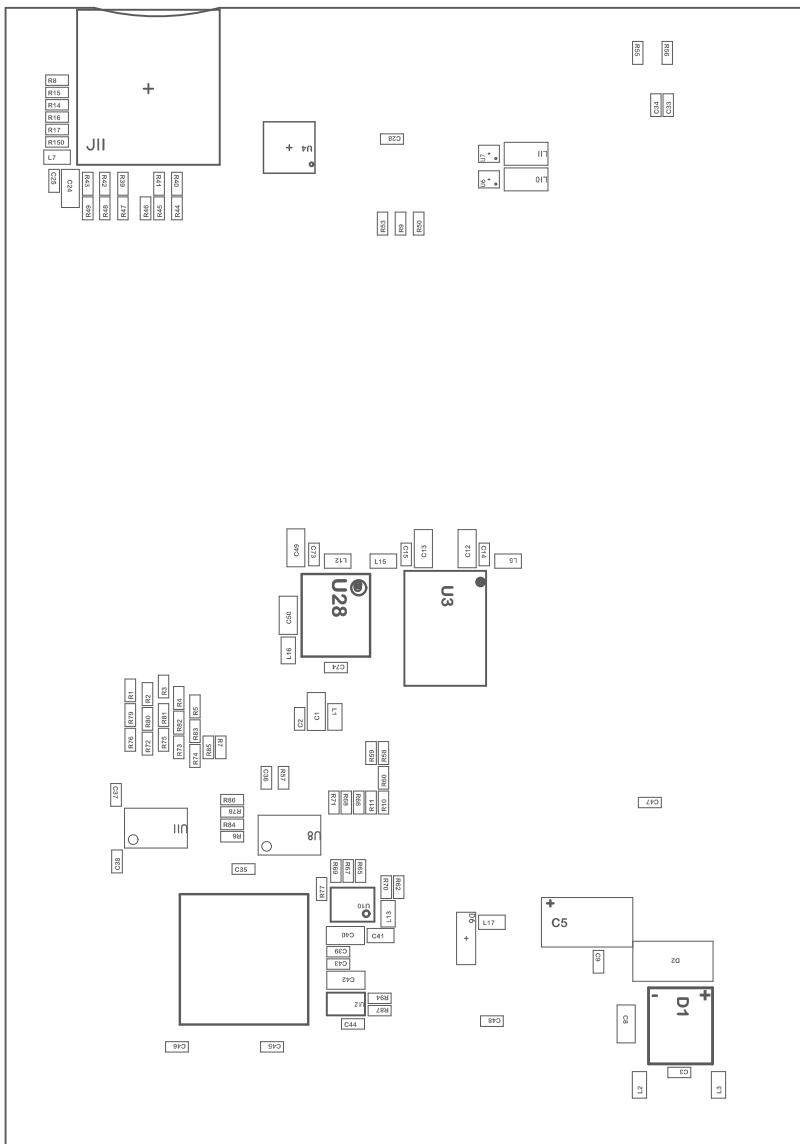
## MECHANICAL CHARACTERISTICS



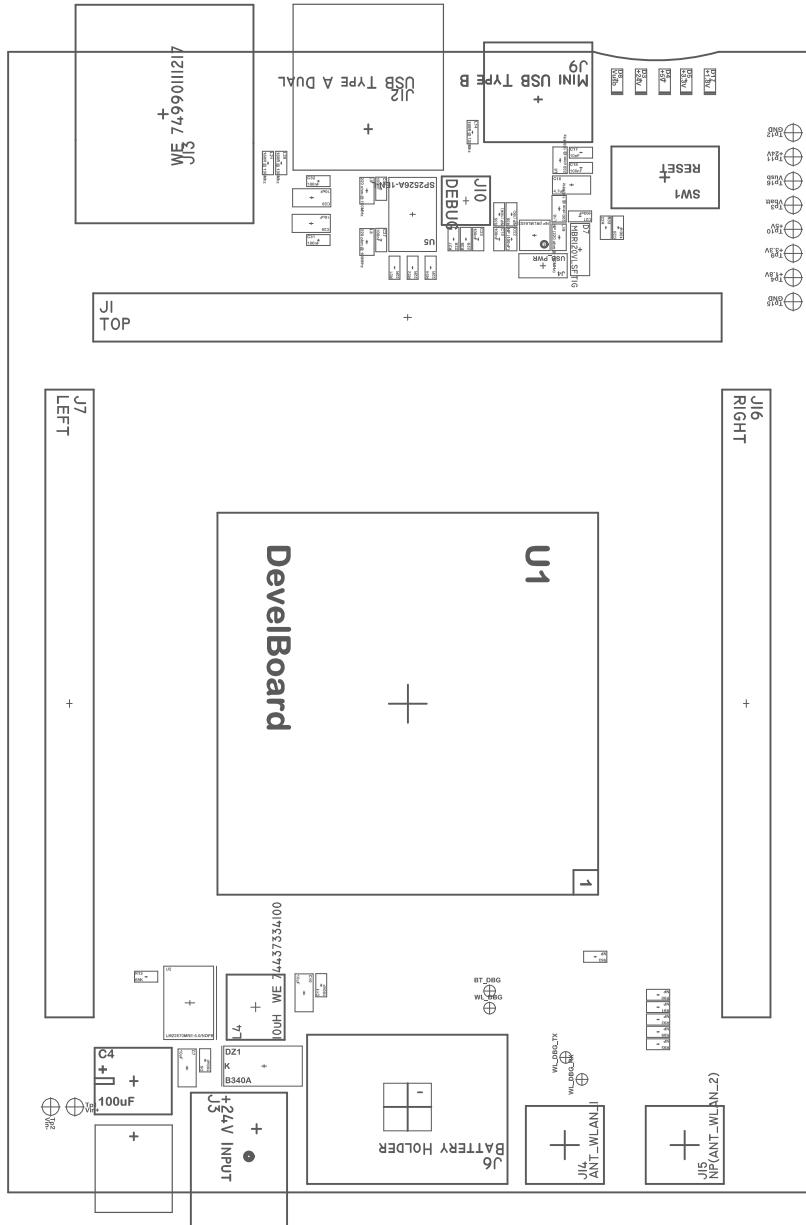
# ASSEMBLY TOP



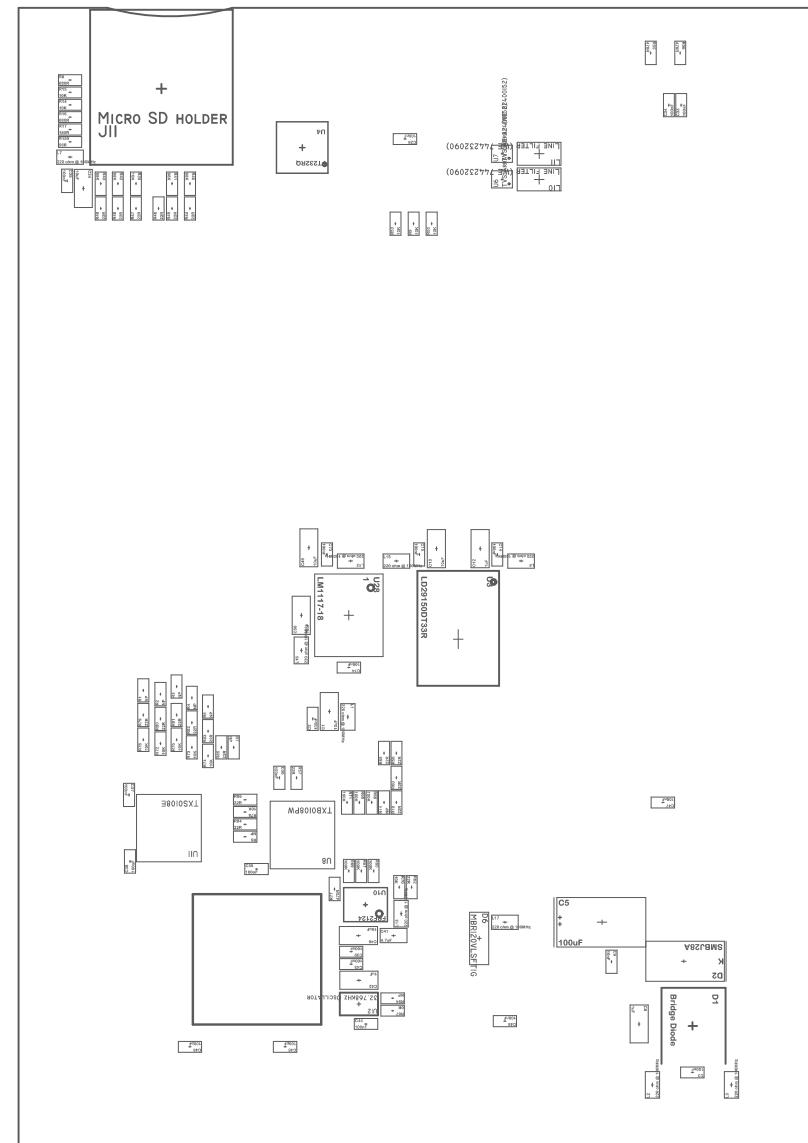
## ASSEMBLY BOTTOM

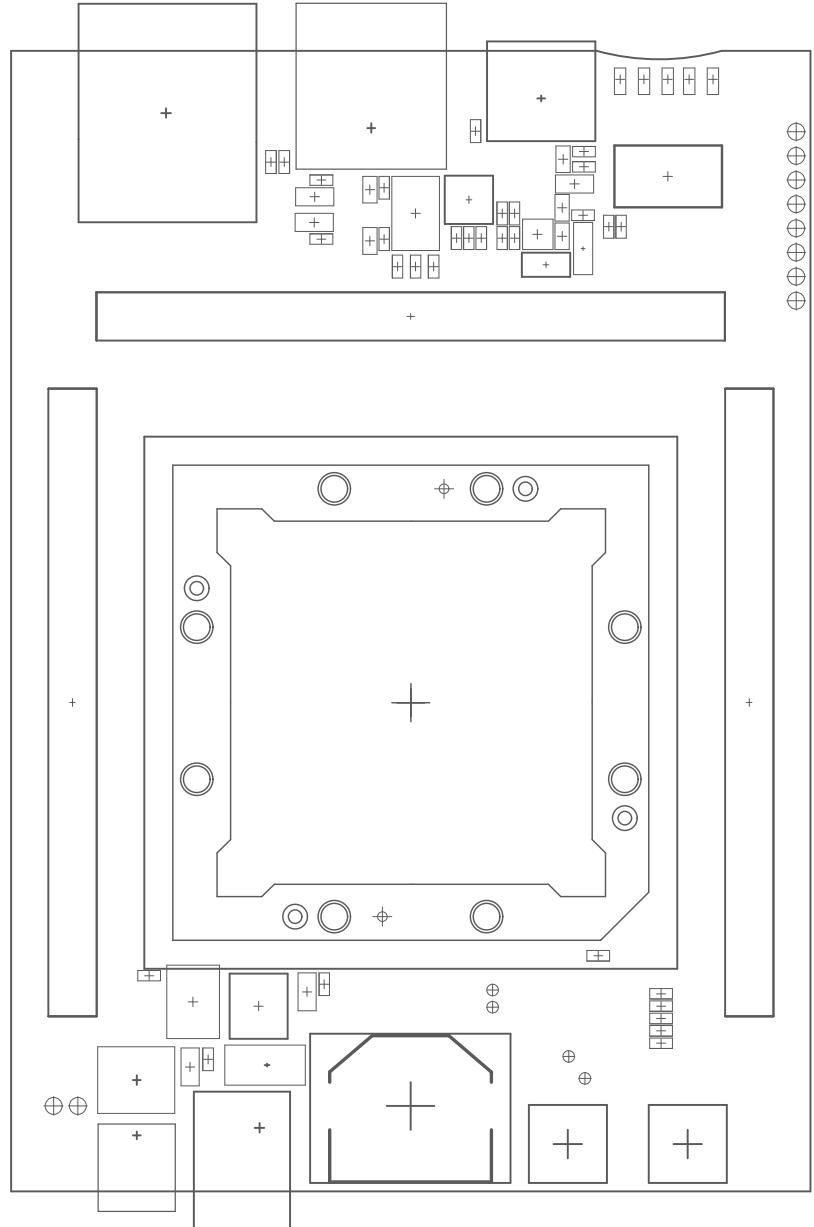


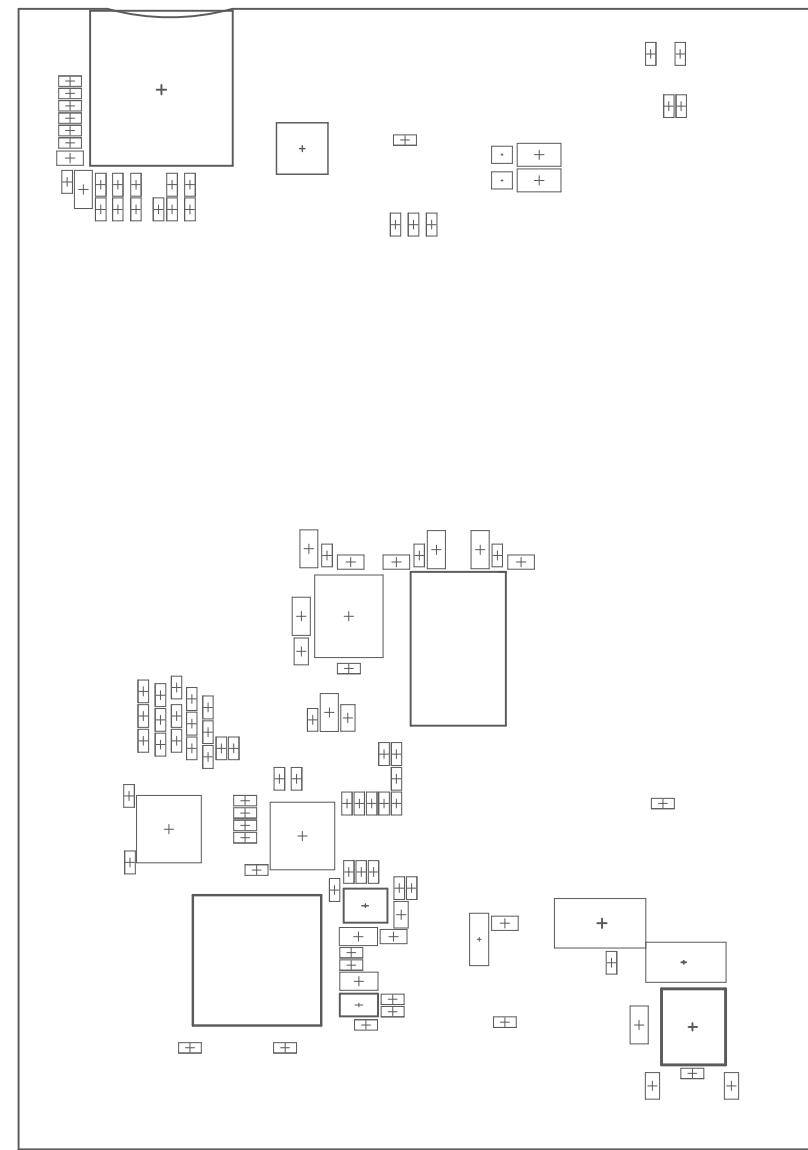
## Note Top

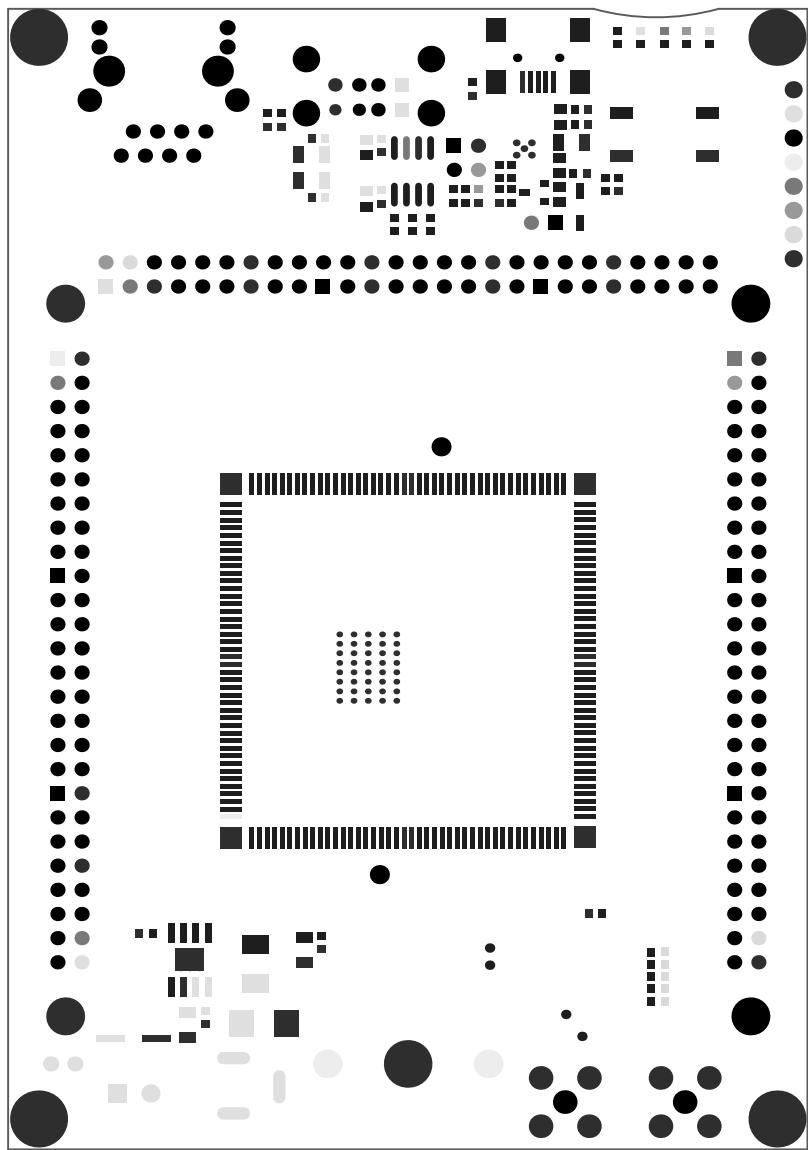


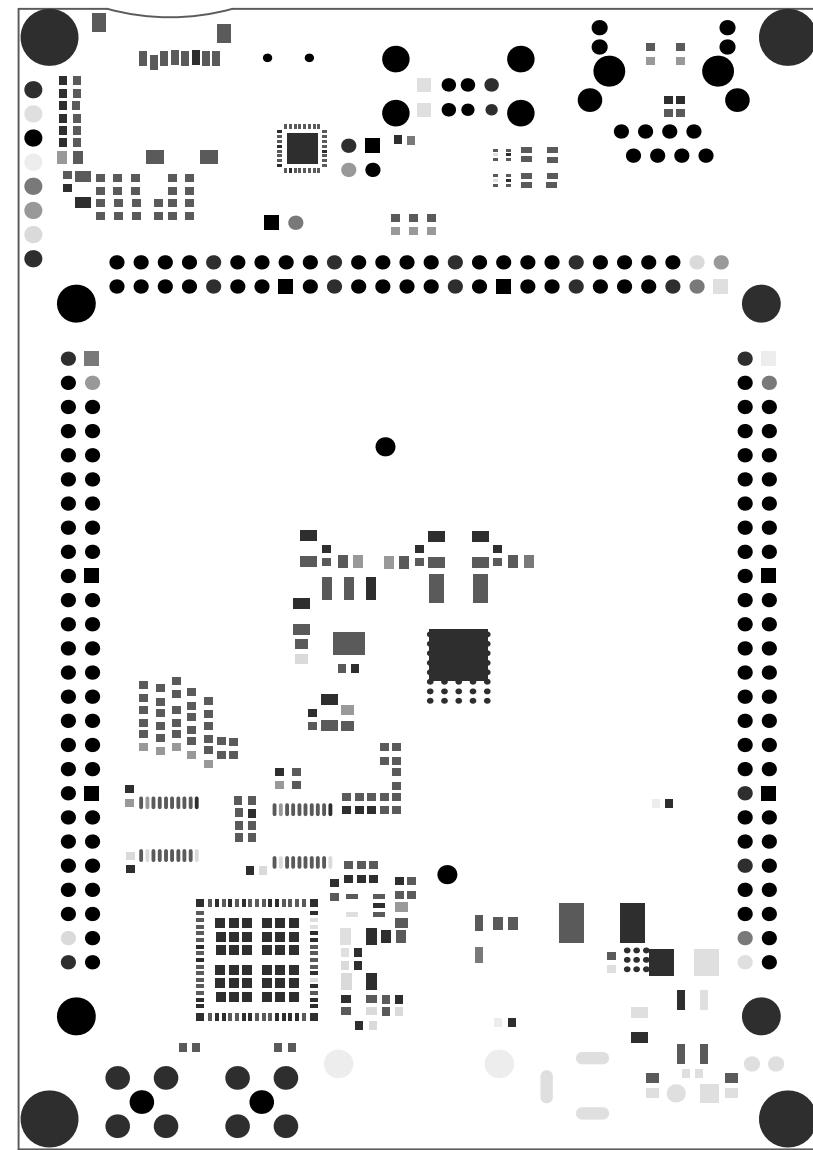
## NOTE BOTTOM

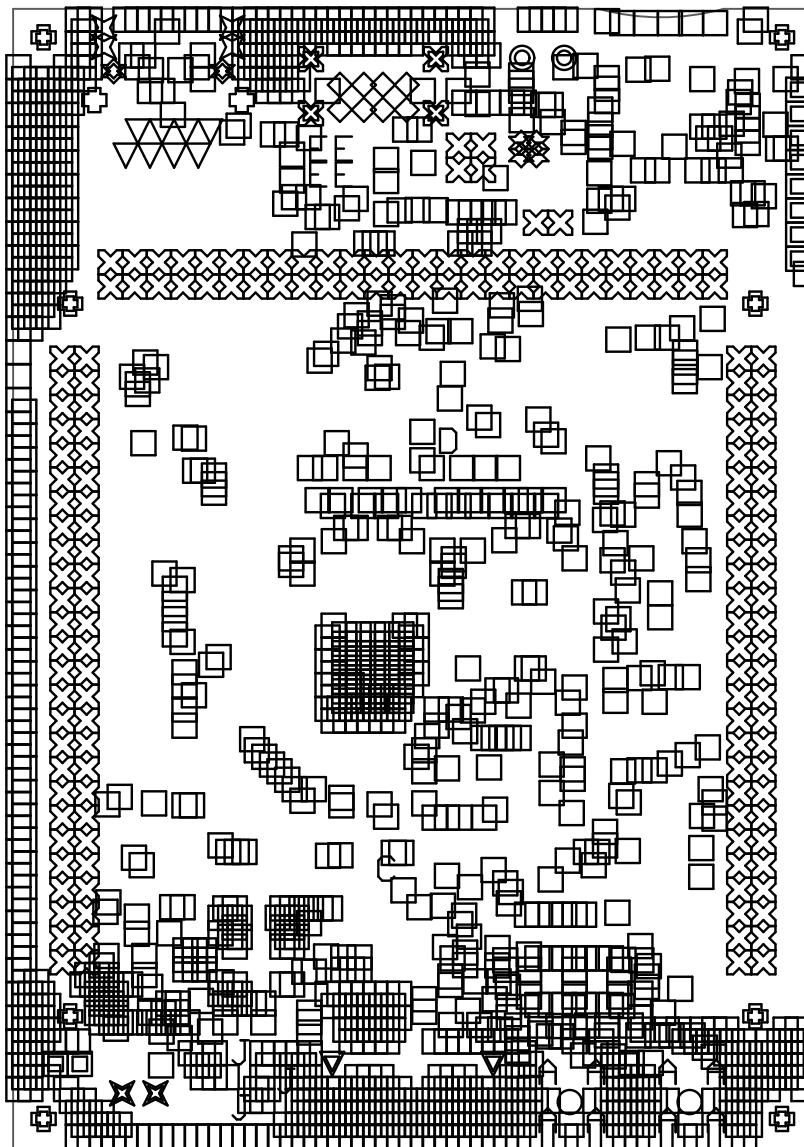












SYMBOL	HIT COUNT	FINISHED HOLE SIZE	PLATED	HOLE TYPE	PHYSICAL LENGTH
C	1	1,150MM (45.28MIL)	NPTH	ROUND	
D	1	1,150MM (45.28MIL)	PTH	ROUND	
●	2	0,900MM (35.43MIL)	NPTH	ROUND	
✖	2	1,400MM (55.12MIL)	PTH	ROUND	
○	2	1,600MM (62.99MIL)	PTH	ROUND	
❖	2	1,630MM (64.17MIL)	PTH	ROUND	
▼	2	1,800MM (70.87MIL)	PTH	ROUND	
*	2	3,250MM (127.95MIL)	PTH	ROUND	
J	3	0,800MM (31.50MIL)	PTH	SLOT	3,000MM (118.11MIL)
E	4	0,250MM (9.84MIL)	PTH	ROUND	
✖	4	1,020MM (40.16MIL)	PTH	ROUND	
✖	4	2,300MM (90.55MIL)	PTH	ROUND	
❖	5	0,350MM (13.78MIL)	PTH	ROUND	
▼	8	0,890MM (35.04MIL)	PTH	ROUND	
◊	8	0,920MM (36.22MIL)	PTH	ROUND	
▲	8	1,700MM (66.93MIL)	PTH	ROUND	
❖	8	3,200MM (125.98MIL)	PTH	ROUND	
□	10	0,950MM (37.40MIL)	PTH	ROUND	
✖	162	0,900MM (35.43MIL)	PTH	ROUND	
□	1221	0,300MM (11.81MIL)	PTH	ROUND	
1459 TOTAL					

SLOT DEFINITIONS : ROUT PATH LENGTH = CALCULATED FROM TOOL START CENTRE POSITION TO TOOL END CENTRE POSITION.  
PHYSICAL LENGTH = ROUT PATH LENGTH + TOOL SIZE = SLOT LENGTH AS DEFINED IN THE PCB LAYOUT

